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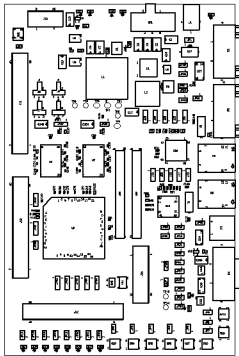
REV 1

1

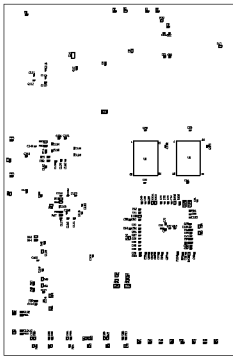
REV		DESCRIPTION		DATE	APPROVED
12	INITIAL RELEASE			2019-01-10	

NOTES: UNLESS OTHERWISE SPECIFIED:

1. APPROPRIATE ESD PRECAUTIONS SHALL BE MAINTAINED AT ALL PHASES OF THE ASSEMBLY, INSPECTION, TESTING AND PACKAGING PROCESS.
2. DIMENSIONS SHALL CONFORM TO IPC-A-610 LEVEL 1.
3. ASSEMBLY SHALL BE PERFORMED USING THIS DRAWING IN CONJUNCTION WITH THE APPROPRIATE BILL OF MATERIALS.
4. UP - ASSEMBLE BGR 404-1020-22A001 SOCKET AND THEN MOUNT ASP600-76404 ON THIS SOCKET.



ASSEMBLY TOP



ASSEMBLY BOTTOM
(SOLDER SIDE VIEW)

1	2	3	4	5	6	7	8
NEXT ASSY USED ON APPLICATION		SEE NOTE 2		MATERIAL:		COMMENTS:	
NEXT ASSY USED ON APPLICATION		SEE NOTE 2		MATERIAL:		COMMENTS:	

87654321

CAD

DATA

2

DO NOT MANUALLY UPDATE

12

1

DATE


2019-01-10

SCALE

1:1

SHEET

1 OF 1

 SANMINA-SCI

DRAWING TITLE

CoreMPT Dev Kit Board